

Ceramic Balun RF Transformer

50Ω 2400 to 2500 MHz 1:2 Ratio

BLNK2-252R+



Generic photo used for illustration purposes only
CASE STYLE: NK0402C

+RoHS Compliant
The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Available Tape and Reel at no extra cost
Reel Size Devices/Reel
7" 20, 50, 100, 200, 500, 1000, 4000

Maximum Ratings

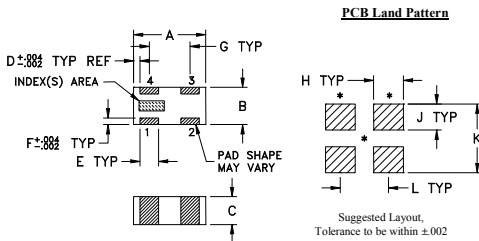
Operating Temperature	-40°C to 85°C
Storage Temperature*	-40°C to 85°C
Input RF Power**	2W at 25°C

*Refer to product storage temperature after installation.
Suggestion for T&R unused product storage condition: +5--+35°C, Humidity 45-75%RH, 12 Month max.
Permanent damage may occur if any of these limits are exceeded.
**Derate linearly to 1W at 85°C.

Pad Connections

PRIMARY DOT (Unbalanced Port)	1
PRIMARY (GND) or DC Feed	2
SECONDARY DOT (Balanced)	3
SECONDARY (Balanced)	4

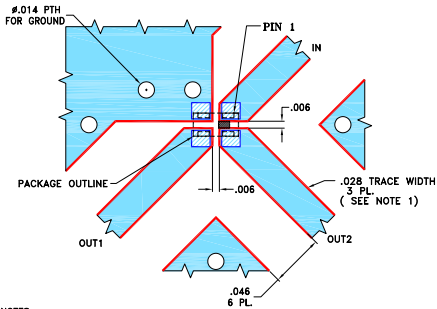
Outline Drawing



Outline Dimensions (inch/mm)

A	B	C	D	E	F	G	H
.039	.020	.015	.004	.010	.004	.022	.016
1.0	0.51	0.38	0.10	0.25	0.10	0.56	0.41
J	K	L	wt				
.014	.037	.026	grams				
0.36	0.94	0.66	.0007				

Evaluation Board MCL P/N: TB-1012+ Suggested PCB Layout (PL-549)



NOTES:
1. TRACE WIDTH IS SHOWN FOR FR4, GRADE IT-180TC (TEG CORR.) WITH DIELECTRIC THICKNESS .016±.0015, COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH & GAP MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

■ DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).
■ DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

Notes

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
C. The parts covered by this specification document are subject to Mini-Circuit's standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuit's website at www.minicircuits.com/MCLStore/terms.jsp

Features

- miniature size 0402 (0.039"[1.0mm] x 0.020"[0.5mm] x 0.015"[0.37mm])
- low phase unbalance, 1.2 deg.
- LTCC construction
- low cost
- aqueous washable

Applications

- ISM Band
- WLAN/Wi-Fi
- Bluetooth
- Zigbee

Electrical Specifications at 25°C

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Unit
Impedance Ratio			2		
Frequency Range		2400	—	2500	MHz
Insertion Loss*	2400 - 2500	—	0.6	1.2	dB
Amplitude Unbalance	2400 - 2500	—	0.5	2	dB
Phase Unbalance†	2400 - 2500	—	1.2	10	Degree
Unbalance Return Loss	2400 - 2500	9	16	—	dB

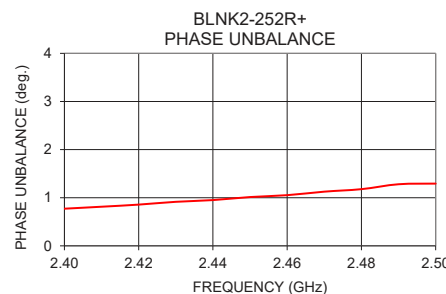
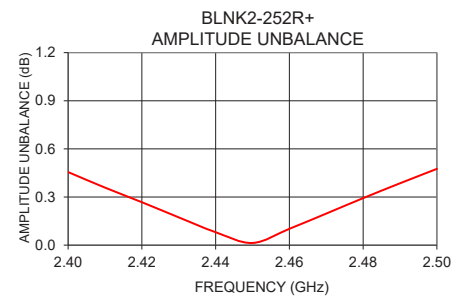
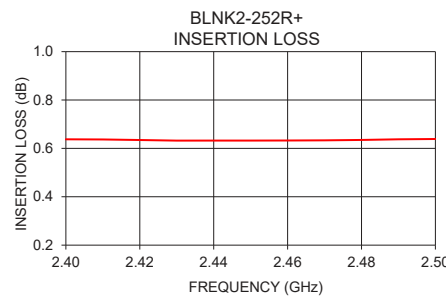
* Tested Evaluation Board TB-1012+

† Relative to 180°

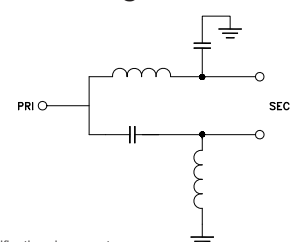
Typical Performance Data at 25°C**

FREQUENCY (GHz)	INSERTION LOSS (dB)	INPUT R. LOSS (dB)	AMPLITUDE UNBALANCE (dB)	PHASE UNBALANCE (Deg.)
2.40	0.64	13.57	0.46	0.77
2.41	0.64	13.58	0.36	0.81
2.42	0.63	13.59	0.27	0.86
2.43	0.63	13.59	0.17	0.91
2.44	0.63	13.61	0.08	0.95
2.45	0.63	13.61	0.01	1.01
2.46	0.63	13.62	0.10	1.05
2.47	0.63	13.63	0.20	1.13
2.48	0.63	13.62	0.29	1.18
2.49	0.64	13.62	0.39	1.28
2.50	0.64	13.62	0.48	1.29

** Measured with Agilent E5071B network analyzer using impedance conversion and port extension.



Configuration S



REV. OR
M172548
BLNK2-252R+
AV/CP/AM
200924